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Please direct all correspondence for this application to customer no. 24341.

I am the:

- ☐ Applicant/Inventor
- ☒ Assignee of record of the entire interest. See 37 CFR 3.71.
(Statement under 37 CFR 3.73(b) is applicable)

Statement Under 37 C.F.R. 3.73(b)

Vextec Corporation states that it is:

- ☒ the assignee of the entire right, title, and interest; or
- ☐ an assignee of less than the entire right, title and interest.
The extent (by, percentage) of its ownership interest is _____ %

in the patent application/patent identified above by virtue of either:

- ☒ An assignment from the inventor(s) of the patent application/patent identified above.
The assignment is submitted herewith for recording.

OR

- ☐ A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as shown below:

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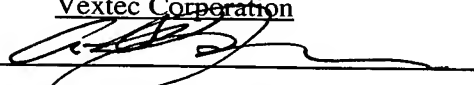
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POWER OF ATTORNEY

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

Date: 2/28/03

ASSIGNEE: Vextec Corporation

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Robert F. Tryron III, et al. Confirmation No.: 6460

Serial No.: 10/043,712 Art Unit: 2857

Filed: January 8, 2002 Examiner: To be assigned

For: *Method and Apparatus for Predicting Failure in a System* Attorney Docket No: 10652-005-999

TRANSMITTAL OF POWER OF ATTORNEY BY ASSIGNEE AND EXCLUSION OF INVENTOR(S) UNDER 37 C.F.R. 3.71 WITH STATEMENT UNDER 37 C.F.R. 3.73(b)

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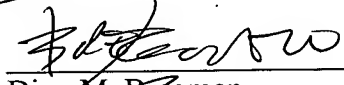
Applicants' attorney encloses herewith a Power of Attorney by Assignee and Exclusion of Inventor(s) Under 37 C.F.R. 3.71 with Under 37 C.F.R. 3.73(b) for the above-referenced application. Applicant's attorney requests that the Power be accepted.

Future correspondence should be directed to customer no. 24341.

The Commissioner is authorized to charge any fees associated with this communication to our deposit account number 16-1150 (order no. 10652-005-999). A copy of this sheet is enclosed for such purpose.

Respectfully submitted,

Date: July 15, 2003


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